





Rohs Test Report

Applicant: SHENZHEN ITOONER TECHNOLOGY CO.,LTD

Address: Building 2&Building 3(The 3rd and 4th Floor) Gangzai Road, Shangxing Community,

Xinqiao Street, Baoan District, Shenzhen, Guangdong, China

The following sample(s) was/were submitted and identified on behalf of the client as:

Product name: Network Cable

Trade name: N/A

GNT-5023, GNT-5005Y, GNT-5005YIP, GNT-5023Y, GNT-5023YIP, GNT-5023T,

Model: GNT-5023TIP, GNT-5023IP, GNT-5027GY, GNT-5027GYIP, GNT-5027, GNT-5027IP,

GNT-5027F, GNT-5027FIP, GNT-50XXX

Manufacturer: SHENZHEN ITOONER TECHNOLOGY CO.,LTD

Address: Building 2&Building 3(The 3rd and 4th Floor) Gangzai Road, Shangxing Community,

Xinqiao Street, Baoan District, Shenzhen, Guangdong, China

Testing

Laboratory:

Shenzhen Huapin Testing Technology Co., Ltd.

Address: Room 302, Comprehensive Building, Songbai Industrial Park, No 4, Yangyong

Industrial Road, Tangxiayong Community, YanluoStreet, Bao'an District, Shenzhen.

Sample

Received Date:

July 06, 2023

Testing Period: July 06, 2023 - July 13, 2023

Test Requirement: Conclusion:

Pass

EU RoHS Directive 2011/65/EU and its amendment directives 2015/863/EU (RoHS 2.0) on Lead, Cadmium, Mercury, Hexavalent Chromium, PBBs, PBDEs, DEHP, BBP, DBP & DIBP content

IEC 62321-3-1:2013 IEC 62321-4:2013+A1:2017

IEC 62321-5:2013 IEC 62321-6:2015

IEC 62321-7-1:2015 IEC 62321-7-2:2017

IEC 62321-8:2017

Wrote by:

Joe Zhong

Reviewed P: T

APPROVED

Approved by:

Thirty Li Date: July 13, 2023

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UAPIN	ETING TECHNOLOGY	CTING	HPT 1-	HPT TESTING	Report No.:HF	PT-230706L012
**	HPT	HPT TESTING	TESTING	HP	HPT TESTIN	Page 2 o
HPTT	Sample No.	Sample Description	Tested Items	XRF Screening Test	Chemical Test (mg/kg)	Conclusion
	-NG	Mr.	Pb	BL	UPTAES	
	STING	,	Cd	BLG	1	-71
HPT		TING	Hg	BL	1	HPT
		TESI	Cr(Cr(VI))	AP BL	1	3
	1	Blue insulating sleeve	Br(PBBs&PBDEs)	BL	THES	PASS
	ESTING	310000	DIBP	1	N.D	
UPTT		"IG	DEHP	ESTING	N.D	UPTT
		TESTING	BBP	APT 17	N.D	G M
		MPT	DBP	/	N.D	
	STING		Pb	BL	HPI	
OT T	65,	- N	Cd	BL	/	77
Hb.		STING	Hg	BL	1	G HA.
		UPT TES	Cr(Cr(VI))	BL	LESTIN	
	STIM2	Transparent Plastic	Br(PBBs&PBDEs)	BL	LIPT/	PASS
	ESTIN		DIBP	1_1NG	N.D	- 1
HPT T		TESTING	DEHP	TEBINI	N.D	HPT
		TTES!	BBP	HPI	N.D	3
		HPTTL	DBP	/	N.D	
	STINIS		Pb	BL	44.	
UPTT		.nIG	Cd	BL	1	UPTT
Lo.		HPT TESTING	Hg	BL	1	3
		HPT	Cr(Cr(VI))	BL	-KESTILL	
	3	Metal	Br(PBBs&PBDEs)	1	HP	PASS
OT T	E2.		DIBP	-GTING	1	
Hb.	STIN33	GTING	DEHP	UPT TES	1	G HPT
		HPT TESTING	BBP	/	LESTIN	
	TING	1.0	DBP	1	HPT/	
	5711	1	Pb	BLAING	1	
HPT T		HPT TESTING	Cd	BL	1	HPT
		TTES!	Hg	BL	1-57111	G
	.0	Hb.	Cr(Cr(VI))	BL	UPT/TESTIN	
	STING	Red Wire	Br(PBBs&PBDEs)	BLG	Hr.	PASS
HPT T		Ttou VVIII	DIBP	TEBTING	N.D	HPTT
		TESTIN	DEHP	APT	N.D	G Y
	100.00	HPT TESTING	BBP	/	N.D	
	STING		DRP	,	N.D	
TT TO	62,	1	W =	HPT TESTING	IN.D	770
HPT				JOT TES		G HPT T
		HPT TESTING		Li	HPT TESTIN	
	CTING	L.	TESTING		HPT	
					2.7	



ATA S	HPT TESTING	HPT 1-	HPT TESTING	Report No.:HF	PT-230706L0125R
HPT	HPT TES	HPT TESTING		TESTIN	Page 3 of 11
SAC		UPT TES !!	CTING	HPI	
Sample No.	Sample Description	Tested Items	XRF Screening Test	Chemical Test (mg/kg)	Conclusion
CTING	1	Pb	BL .c	1	TES
E51.	, NG	Cd	BL	/	HPT TES
	TESTING	Hg	AP BL	1	G
	HB1.	Cr(Cr(VI))	BL	THES	
5 1115	White Wire	Br(PBBs&PBDEs)	BL	HEST	PASS
	-ING	DIBP	STINE	N.D	HPT TEL
	HPT TESTING	DEHP	APT 1	N.D	G
	Hb.	BBP	/	N.D	
CTING		DBP	1	N.D	20
	ING	Pb	BL	1	HPT TES
	TESTIN	Cd	BL	1	G
	Hb1.	Hg	BL	TES !!	
6		Cr(Cr(VI))	BL	HPI	DAGG
6	Blue Wire	Br(PBBs&PBDEs)	BL	/	PASS
	TESTIL	DIBP	IPT TY	N.D	G
-	HPI	DEHP	/	N.D	_
ESTING		BBP	1-1010	N.D	TES
	ING	DBP Pb	BL	N.D	UPT 7
	HPT TESTING		BL	1 -711	G
	HPI	Cd Hg	BL	Lestin	-
STING		Cr(Cr(VI))	BL	HPT/	DOT TES
STING 7	Green Wire	Br(PBBs&PBDEs)	BL		PASS
		DIBP	HPT 1	N.D.	G
10	HPT TES	DEHP	/	N.D	1
STING		BBP	LING	N.D	-65
ESTING	TING	DBP	TEBTILL	N.D	HPT TES
	HPT TEST	Pb	BL	/ITO	10
-16	HA.	Cd	BL	PLATER	
ESTING		Hg	BLG	1	HPT TES
	TING	Cr(Cr(VI))	BL	1	HPT
8	Orange wire	Br(PBBs&PBDEs)	BL	1 STIN	PASS
-16	HA.	DIBP	/	N.D	
STING		DEHP	1	N.D	-cS
ESTING	TING	BBP	STILL	N.D	G HPT TES
	TES!"	DBP	APT 1	N.D	G
ESTING	HPT	HPT TESTING		HPT TESTIN	HPTTES
CTIM		OT TEN	TT TESTING		



0	01.6	Hb.	VDE	Observation I Total	.01
Sample No.	Sample Description	Tested Items	XRF Screening Test	Chemical Test (mg/kg)	Conclusion
-ING	(3)	Pb	BL	HPT/	
1110		Cd	BL	1	-
	TING	Hg	BL	/	HPI
	OT TES	Cr(Cr(VI))	BL	1-STIN	13
9	Brown Wire	Br(PBBs&PBDEs)	BL	UPTAE	PASS
Llin		DIBP	1 -ING	N.D	
	CTING	DEHP	TEBIN	N.D	HPT
	OT TES!	BBP	1	N.D	(3
	yr.	DBP	/	N.D	HPT

NG



Remark:

- (1) (a) It is the result on total Br while test item on restricted substances is PBBs/PBDEs. It is the result on total Cr while test item on restricted substances is Cr(VI).
 - (b)Results are obtained by EDXRF for primary screening, and further chemical testing by ICP-OES (for Cd, Pb, Hg), UV-Vis (for Cr (VI)) and GC/MS (for PBBs, PBDEs) is recommended to be performed, if the concentration exceeds the below warning value according to IEC62321-3- 1:2013 (unit: mg/kg)

Element	Polymer	Metal	Composite Materials
Cd	BL≤(70-3σ) <x<(130+3σ)< td=""><td>BL≤(70-3σ)<x<(130+3σ)< td=""><td>LOD<x<(150+3σ) td="" ≤ol<=""></x<(150+3σ)></td></x<(130+3σ)<></td></x<(130+3σ)<>	BL≤(70-3σ) <x<(130+3σ)< td=""><td>LOD<x<(150+3σ) td="" ≤ol<=""></x<(150+3σ)></td></x<(130+3σ)<>	LOD <x<(150+3σ) td="" ≤ol<=""></x<(150+3σ)>
	≤OL	≤OL	_c^
Pb	BL≤(700-3σ) <x<(1300+3σ)< td=""><td>BL≤(700-</td><td>BL≤(500-</td></x<(1300+3σ)<>	BL≤(700-	BL≤(500-
UPT TES	≤OL	3σ) <x<(1300+3σ) td="" ≤ol<=""><td>3σ)<x<(1500+3σ) td="" ≤ol<=""></x<(1500+3σ)></td></x<(1300+3σ)>	3σ) <x<(1500+3σ) td="" ≤ol<=""></x<(1500+3σ)>
Hg	BL≤(700-3σ) <x<(1300+3σ)< td=""><td>BL≤(700-</td><td>BL≤(500-</td></x<(1300+3σ)<>	BL≤(700-	BL≤(500-
rig	≤OL	3σ) <x<(1300+3σ) td="" ≤ol<=""><td>3σ)<x<(1500+3σ) td="" ≤ol<=""></x<(1500+3σ)></td></x<(1300+3σ)>	3σ) <x<(1500+3σ) td="" ≤ol<=""></x<(1500+3σ)>
Br TES	BL≤(300-3σ) <x< td=""><td>HPT</td><td>BL≤(250-3σ)<x< td=""></x<></td></x<>	HPT	BL≤(250-3σ) <x< td=""></x<>
Cr	BL≤(700-3σ) <x< td=""><td>BL≤(700-3σ)<x< td=""><td>BL≤(500-3σ)<x< td=""></x<></td></x<></td></x<>	BL≤(700-3σ) <x< td=""><td>BL≤(500-3σ)<x< td=""></x<></td></x<>	BL≤(500-3σ) <x< td=""></x<>

- (c) BL = Below warning value, OL = Over Limit, IN = Inconclusive,LOD = Limit of Detection, -- = Not Regulated, NA = Not Applicable.
- (d) The XRF screening test for RoHS elements The reading may be different to the actual content in the sample be of non-uniformity composition.
- (2) (a) 1mg/kg = 1ppm = 0.0001%, N.D.= Not Detected (<MDL), --- = Not Conducted.
- (b) Unit and Method Detection Limit (MDL) in wet chemical test

Test Items	Pb	Cd	Hg
Units	mg/kg	mg/kg	mg/kg
MDL	2	2/16	2 TEST

The MDL for single compound of PBBs & PBDEs is 5 mg/kg, MDL of Cr(VI) for polymer

- & composite sample is 2 mg/kg and MDL of DBP, BBP, DEHP and DIBP is 30mg/kg.
- (c) When Cr(VI) for metal sample is testing according to IEC 62321-7-1:2015, the unit is



pg/cm², and the MDL is 0,10 pg/cm². When the Cr (VI) concentration is > the 0,13 pg/cm², the sample is positive for Cr(VI) and considered to contain Cr(VI); when the Cr (VI) concentration is N.D.(< the 0,10 pg/cm²), the sample is negative for Cr(VI) and considered a non-Cr(VI) based coating; when the Cr (VI) concentration is \geq the 0,10 pg/cm² and \leq the 0,13 pg/cm², the result is considered to be inconclusive

- Unavoidable coating variations may influence the determination.
- (3) The maximum permissible limit is quoted from the Directive (EU) 2015/863 Amendment of EU RoHS Directive 2011/65/EU (RoHS 2.0) Annex II.

RoHS Restricted Substances	Maximum Concentration Value (by weight in homogenous materials)		
Lead (Pb)	0.1%		
Cadmium (Cd)	0.01%		
Mercury (Hg)	0.1%		
Hexavalent Chromium (Cr VI)	0.1%		
Polybrominated biphenyls (PBBs)	0.1%		
Polybrominated diphenylethers (PBDEs)	0.1%		
Dibutyl Phthalate (DBP)	0.1%		
Benzylbutyl Phthalate (BBP)	0.1%		
Bis-(2-ethylhexyl) Phthalate (DEHP)	0.1%		
Diisobutyl Phthalate (DIBP)	0.1%		

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HPT	Page 7 o
	NOT TEST
STINE HPT TEE	
RoHS Exemptions	Hb1,
RoHS Directive 2011/65/EU ANNEX III and (EU)2017/2102	-cTING
Exemption Items	Expires Date
1, Mercury in single capped (compact) fluorescent lamps not	- 11
exceeding (per burner):	Hb1.
1(a), For general lighting purposes < 30 W:3,5 mg	2,5 mg shall be used per bur
ING HI	after 31 December 2012
1(b), For general lighting purposes≥ 30 W and < 50W:3,5mg	- 1
1(c), For general lighting purposes ≥ 50 W and < 150 W: 5 mg	Hbj
1(d), For general lighting purposes ≥ 150 W: 15 mg	CCTING
1(e), For general lighting purposes with circular or square	UPTTE
structural shape and tube diameter ≤ 17 mm: 7 mg	
1(f), For special purposes: 5 mg	Hb1.
2(a), Mercury in double-capped linear fluorescent lamps for	STING
general lighting purposes not exceeding (per lamp):	UPTTE
2(a)(1), Tri-band phosphor with normal lifetime and a tube	7
diameter < 9 mm (e.g. T2): 4 mg	HPI
2(a)(2), Tri-band phosphor with normal lifetime and a tube	STING
diameter ≥ 9 mm and ≤ 17 mm (e.g. T5): 3 mg	UPT TES
2(a)(3), Tri-band phosphor with normal lifetime and a tube	
diameter > 17 mm and ≤ 28 mm (e .g . T8):3 .5mg	HP1.
2(a)(4), Tri-band phosphor with normal lifetime and a tube	Expires on 31 December 20
diameter > 28 mm (e.g. T12): 5 mg	3,5 mg may be used per lamp a
diameter > 20 mm (e.g. 112). 5 mg	31 December 2012
2(a)(5), Tri-band phosphor with long lifetime (≥ 25 000 h): 5 mg	HA
2 (b), Mercury in other fluorescent lamps not exceeding (per	ESTING
lamp):	HPT 72
2(b)(2), Non-linear halophosphate lamps (all diameters): 15 mg	Expires on 13 April 2016
2(b)(3), Non-linear tri-band phosphor lamps with tube diameter > 17	IC Hb.
mm (e.g. T9):15mg	TESTING
2(b)(4), Lamps for other general lighting and special purposes (e.g.	HPT
induction lamps):15 mg	Hr.
3, Mercury in cold cathode fluorescent lamps and external electrode	
fluorescent lamps (CCFL and EEFL) for special purposes not	HPT TESTING M.
exceeding (per lamp):	HPT
3(a), Short length (≤500 mm):3.5mg	mT.
3(b), Medium length (> 500 mm and ≤ 1 500 mm):5mg	-iG Hh,
3(c), Long length (> 1 500 mm):13mg	TESTING
4(a), Mercury in other low pressure discharge lamps (per lamp):15mg	HPT
4(b), Mercury in High Pressure Sodium (vapour) lamps for general	at T
lighting purposes not exceeding (per burner) in lamps with improved	HK,
colour rendering index Ra>60:	TESTING
colour remaening index K8/00.	177



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	HPT TES
HPT	TT
Exemptions	HP
RoHS Directive 2011/65/EU ANNEX III and (EU)2017/2102	ESTING
Exemption Items	Expires Date
I(b) -I, P ≤ 155 W:30mg	- TF
I(b) -II, 155 W < P ≤ 405 W:40mg	HPI
I(b) -III, P > 405 W:40mg	ESTING
(c), Mercury in other High Pressure Sodium (vapour) lamps for	HPTTE
peneral lighting purposes not exceeding (per burner):	TT
l(c)-I, P ≤ 155 W:25mg	HPI
I(c)-II, 155 W < P ≤ 405 W:30mg	STING
l(c)-III, P > 405 W:40mg	UPTTE
(d), Mercury in High Pressure Mercury (vapour) lamps (HPMV)	Expires on 13 April 2015
l(e), Mercury in metal halide lamps (MH)	HP1
(f), Mercury in other discharge lamps for special purposes not	-cTING
specifically mentioned in this Annex	UPTTES
5(a), Lead in glass of cathode ray tubes	75
5(b), Lead in glass of fluorescent tubes not exceeding 0,2 % by weight	HPT
6(a), Lead as an alloying element in steel for machining purposes and in	F
galvanized steel containing up to 0,35 % lead by weight	Expires on 21 July 2026
10/	= : 04 1 1 0000 (0 00V)
6(b)-I, Lead as an alloying element in aluminium containing up to 0,4 % lead by weight	Expires on 21 July 2026(0.3%)
7,4 % lead by weight	Expires on 21 July 2026 and at
S(b)-II, Lead as an alloying element in aluminium containing up to	that date may be used in spare pa
0,4 % lead by weight	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
TING	for EEE placed on the market before
C(a) Connar alloy containing up to 4.0/ load by waight	31 December 2024
6(c), Copper alloy containing up to 4 % lead by weight	Expires on 21 July 2026
7(a), Lead in high melting temperature type solders (i.e. lead- based	Expires on 21 July 2026
alloys containing 85 % by weight or more lead)	HPT
7 (b), Lead in solders for servers, storage and storage array systems,	CING
network infrastructure equipment for switching, signalling,	JOT TES
ransmission, and network management for telecommunications	M
7 (c)-I, Electrical and electronic components containing lead in a glass	Expires on 21 July 2026
or ceramic other than dielectric ceramic in capacitors, e.g.	TING
piezoelectronic devices, or in a glass or ceramic matrix compound	OT TES
(c)-II, Lead in dielectric ceramic in capacitors for a rated voltage of	Expires on 21 July 2026
125 V AC or 250 V DC or higher	UPT TI
	Expires on 1 January 2013 a
7(c)-III, Lead in dielectric ceramic in capacitors for a rated voltage of	after that date may be used in spa
ess than 125 V AC or 250 V DC	parts for EEE placed on the man
ING HT	before 1 January 2013
(c)- IV, Lead in PZT based dielectric ceramic materials for capacitors	Expires on 21 July 2016
peing part of integrated circuits or discrete semiconductors	TESI

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	Hit .	TESTINE	Report No.:HPT-2	30706L0125R
HPT &		HPT .	CTING	Page 9 of 11
- Level	ESTING		UPT TES	
Clina	HPTT	TING	Li.	TEST
cemptions oHS Directive 2011/65/EU	ANNEY III and (ELI)20	117/2102		HBJ
77	ANNEX III and (EU)20	31772102	Evniron Data	
cemption Items	TESTING		Expires Date	m. 2012
a), Cadmium and its compou	unds in one shot pelle	t type thermal cut-	Expires on 1 Janua	TED.
s sTING		IDT TES	after that date may	E.L.
UPT TES		ble	spare parts for EEE	
(b), Cadmium and its compo	unds in electrical cont	acts	market before 1 Janu	lary 2012
•	Hr.	Dln-		TEST
, Hexavalent chromium as ar	•			HA
poling system in absorption re e cooling solution	enigerators up to 0,7	5 70 by weight in	TESTING	
(b), Lead in bearing shells	and husbes for ref	rigerant-containing	HPT	-4
ompressors for heating, venti	Hr	TING		HPT TEST
ompressors for fleating, ventions	iadon, an conditioning	g and reingeration	-16	HL.
TIVACITY APPLICATIONS	-ING	1.0	May be used in sp	are narts for
1(a), Lead used in C-press co	ompliant pin connecto	r systems	EEE placed on the r	0.00
, G	Hb.	STING	24 September 2010	namer before
TESTING		HPT TES	Expires on 1 Janua	ry 2013 and
1(b), Lead used in other than	C-press compliant pi	n connector	after that date may	
ystems	INT TES!		spare parts for EEE	
n.G.	Hb.	TESTING	market before 1 Janu	-75-
O L L TESTING		HPTTE	May be used in sp	1.4.
2, Lead as a coating material	for the thermal condu	action module C-	EEE placed on the r	
ing	OT TES	, Co	24 September 2010	-61
3(a), Lead in white glasses u	sed for optical applica	ations		UPT TE
3(b), Cadmium and lead in fi		107 10	TING	
eflectance standards	CTING		TESI	
4, Lead in solders consisting	g of more than two	elements for the	Hr.	-551
onnection between the pins a	and the package of i	micropro- cessors	Expires on 21 July 2	026
rith a lead content of more that	n 80 % and less than	85 % by weight		
5, Lead in solders to comple	te a viable electrical d	connection between	IDT TES	
emiconductor die and carri	ier within integrated	circuit flip chip	ku.	HPT TEST
ackages	4.5	TESTIL		HPT
6, Lead in linear incandescer	nt lamps with silicate o	coated tubes	Expires on 1 Septem	
7, Lead halide as radiant age	ent in high intensity dis	scharge (HID)	UPT TES	- ~ 1
amps used for professional re	eprography application	nsG	Liv	TEST
8(b), Lead as activator in the	fluorescent powder (1	l % lead by weight		HPI
r less) of discharge lamps	s when used as so	un tanning lamps	- CTING	
ontaining phosphors such as E	BSP (BaSi ₂ O ₅ :Pb)		UPT TES	
1110	ting inks for the applic	cation of enamels	1.0	HPT TEST
11, Lead and cadmium in prin				- (3)
 Lead and cadmium in prin n glasses, such as borosilicat 	te and soda lime glas	ses	- 29	Hr.
	te and soda lime glas	ses	UPT TESTING	Hr.

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MG



- nG	HPT TESTING	rage 10 01 11
Exemptions	HPT	-ING III
RoHS Directive 2011/65/EU ANNI	EX III and (EU)2017/2102	TTESI
Exemption Items	IDT TES!	Expires Date
23, Lead in finishes of fine pitch own with a pitch of 0,65 mm and less	components other than connectors	May be used in spare parts for EEE placed on the market before 24 September 2010
24, Lead in solders for the solder discoidal and planar array cerami	Hr.	HPT TEST
2.5 , Lead oxide in surface conductused in structural elements, notable	tion electron emitter displays (SED) y in the seal frit and frit ring	INTTESTING
29, Lead bound in crystal glass as and 4) of Council Directive 69/493.	defined in Annex I (Categories 1, 2, 3 /EEC (1)	HPT TEST
conductors located directly on th	mechanical solder joints to elec-trical ne voice coil in transducers used in ound pressure levels of 100 dB (A)	HPT TESTING HPT TEST
(1D.)	n mercury free flat fluorescent lamps crystal displays, design or industrial	HPT TESTING
32, Lead oxide in seal frit used fo Argon and Krypton laser tubes	or making window assemblies for	-cTING HPT I
33, Lead in solders for the solderin		HPT TEST
34, Lead in cermet-based trimme	r potentiometer elements	HPT
37, Lead in the plating layer of higzinc borate glass body	gh voltage diodes on the basis of a	HPT TESTING
38, Cadmium and cadmium oxide aluminium bonded beryllium oxide	Tr. CTII	HPT TEST
CIP.	II-VI LEDs (< 10 pg Cd per mm ² of d state illumination or display systems	Expires on 1 July 2014
40, Cadmium in photoresistors for professional audio equipment	or analogue optocouplers applied in	Expires on 31 December 2013

2. For the purposes of Directive 2011/65/EU, a maximum concentration value of 0,1 % by weight in homogeneous materials for lead, mercury, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE) and of 0,01 % by weight in homogeneous materials for cadmium shall be tolerated.

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HPT TESTING

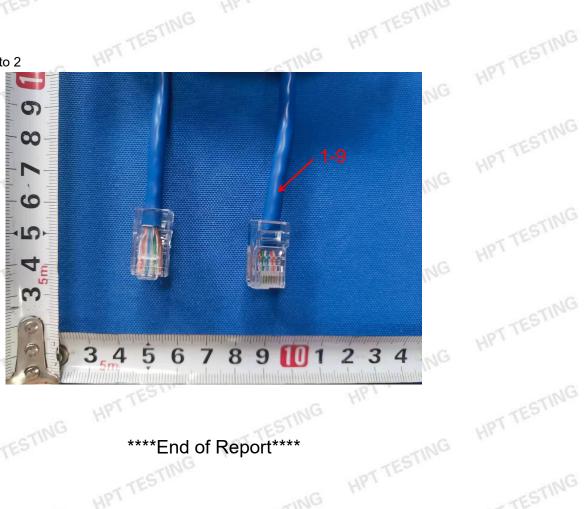


HPT TESTING Sample photo

EUT Photo 1



HPT TESTING **EUT Photo 2**



****End of Report**** HPT TESTING